

# 4 x 40W QUAD BRIDGE CAR RADIO AMPLIFIER

- HIGH OUTPUT POWER CAPABILITY: 4 x 45W/4Ω MAX. 4 x 40W/4Ω EIAJ 4 x 28W/4Ω @ 14.4V, 1KHz, 10% LOW OUTPUT NOISE
  ST-BY FUNCTION

- MUTE FUNCTION
- AUTOMUTE AT MIN. SUPPLY VOLTAGE DE-**TECTION**
- LOW EXTERNAL COMPONENT COUNT: - INTERNALLY FIXED GAIN (26dB)
  - NO EXTERNAL COMPENSATION
  - NO BOOTSTRAP CAPACITORS

#### **PROTECTIONS:**

- OUTPUT SHORT CIRCUIT TO GND, TO Vs, ACROSS THE LOAD
- VERY INDUCTIVE LOADS
- OVERRATING CHIP TEMPERATURE WITH SOFT THERMAL LIMITER
- LOAD DUMP VOLTAGE
- FORTUITOUS OPEN GND

#### **BLOCK AND APPLICATION DIAGRAM**

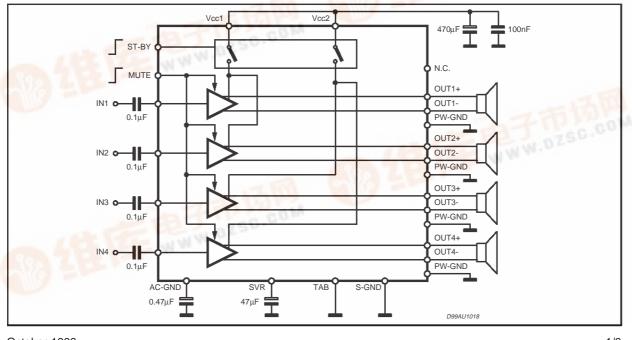


- REVERSED BATTERY
- ESD

#### DESCRIPTION

The TDA7386 is a new technology class AB Audio Power Amplifier in Flexiwatt 25 package designed for high end car radio applications.

Thanks to the fully complementary PNP/NPN output configuration the TDA7386 allows a rail to rail output voltage swing with no need of bootstrap capacitors. The extremely reduced components W.DZS count allows very compact sets.

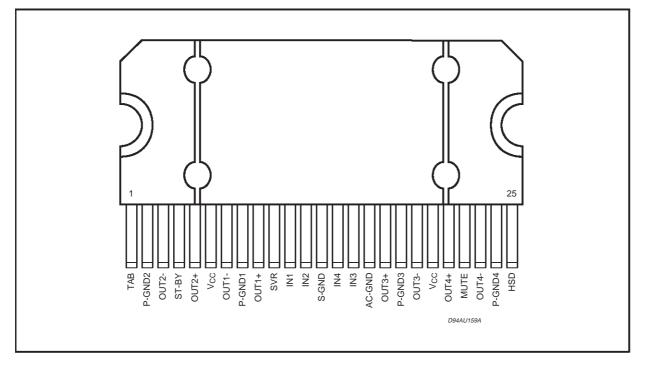


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#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Operating Supply Voltage	18	V
V <sub>CC (DC)</sub>	DC Supply Voltage	28	V
V <sub>CC (pk)</sub>	Peak Supply Voltage (t = 50ms)	50	V
I <sub>O</sub>	Output Peak Current: Repetitive (Duty Cycle 10% at f = 10Hz) Non Repetitive (t = 100μs)	4.5 5.5	AA
P <sub>tot</sub>	Power dissipation, $(T_{case} = 70^{\circ}C)$	80	W
Tj	Junction Temperature	150	°C
T <sub>stg</sub>	Storage Temperature	– 55 to 150	°C

# **PIN CONNECTION** (Top view)



#### THERMAL DATA

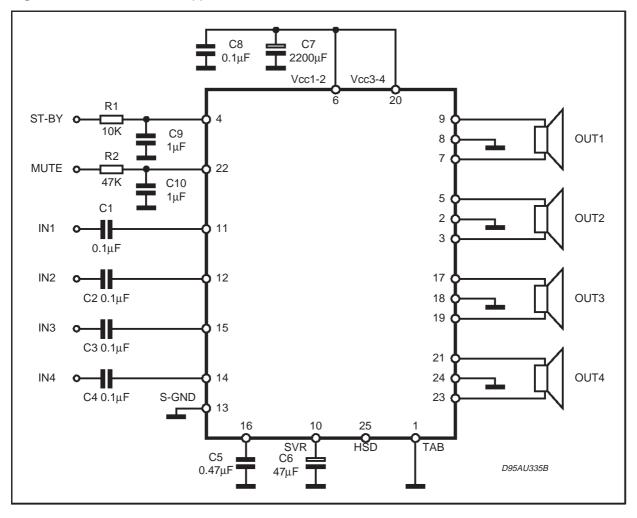
Symbol	Parameter		Value	Unit
R <sub>th j-case</sub>	Thermal Resistance Junction to Case	Max.	1	°C/W

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
l <sub>q1</sub>	Quiescent Current	$R_L = \infty$		190	350	mA
V <sub>OS</sub>	Output Offset Voltage	Play Mode			<u>+</u> 80	mV
dV <sub>OS</sub>	During mute ON/OFF output offset voltage				±80	mV
Gv	Voltage Gain		25	26	27	dB
dGv	Channel Gain Unbalance				±1	dB
Po	Output Power	$\begin{array}{l} V_S = 13.2 \text{V}; \ \text{THD} = 10\% \\ V_S = 13.2 \text{V}; \ \text{THD} = 0.8\% \\ V_S = 14,4 \text{V}; \ \text{THD} = 10\% \end{array}$	22 16.5 26	24 18 28		W W W
Po EIAJ	EIAJ Output Power (*)	Vs = 13.7V	37.5	40		W
Po max.	Max. Output Power (*)	V <sub>S</sub> = 14.4V	43	45		W
THD	Distortion	$P_o = 4W$		0.04	0.15	%
e <sub>No</sub>	Output Noise	"A" Weighted Bw = 20Hz to 20KHz		50 70	70 100	μV μV
SVR	Supply Voltage Rejection	$f = 100Hz; V_r = 1Vrms$	50	75		dB
f <sub>ch</sub>	High Cut-Off Frequency	$P_0 = 0.5W$	80	200		KHz
R <sub>i</sub>	Input Impedance		70	100		KΩ
CT	Cross Talk	$      f = 1 KHz  P_O = 4W \\       f = 10 KHz  P_O = 4W $	60	70 60	_ _	dB dB
I <sub>SB</sub>	St-By Current Consumption	$V_{St-By} = 1.5V$			100	μΑ
I <sub>pin4</sub>	St-by pin Current	VSt-By = 1.5V to 3.5V			±10	μA
V <sub>SB out</sub>	St-By Out Threshold Voltage	(Amp: ON)	3.5			V
$V_{\text{SB in}}$	St-By in Threshold Voltage	(Amp: OFF)			1.5	V
A <sub>M</sub>	Mute Attenuation	$P_{Oref} = 4W$	80	90		dB
V <sub>M out</sub>	Mute Out Threshold Voltage	(Amp: Play)	3.5			V
V <sub>M in</sub>	Mute In Threshold Voltage	(Amp: Mute)			1.5	V
$V_{AM \ in}$	V <sub>S</sub> Automute Threshold	(Amp: Mute) Att $\geq$ 80dB; P <sub>Oref</sub> = 4W (Amp: Play)		7.0	6.5	V
		$Att < 0.1 dB; P_0 = 0.5W$		7.6	8.5	V
I <sub>pin22</sub>	Muting Pin Current	V <sub>MUTE</sub> = 1.5V (Sourced Current)	5	11	20	μΑ
		$V_{MUTE} = 3.5V$	-5		20	μΑ

**ELECTRICAL CHARACTERISTICS** (V<sub>S</sub> = 14.4V; f = 1KHz; R<sub>g</sub> = 600 $\Omega$ ; R<sub>L</sub> = 4 $\Omega$ ; T<sub>amb</sub> = 25°C; Refer to the test and application diagram, unless otherwise specified.)

(\*) Saturated square wave output.

Figure 1: Standard Test and Application Circuit



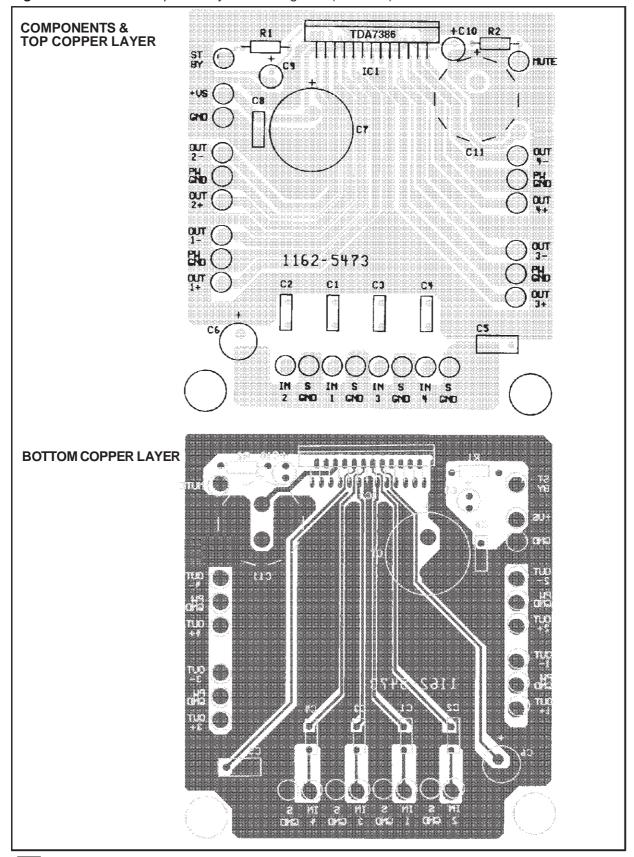


Figure 2: P.C.B. and component layout of the figure 1 (1:1 scale)

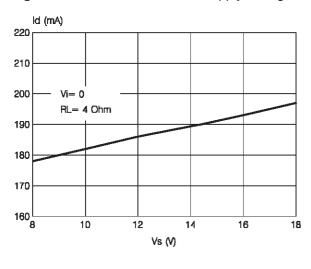
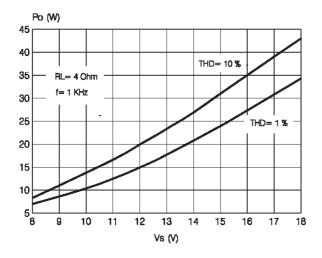
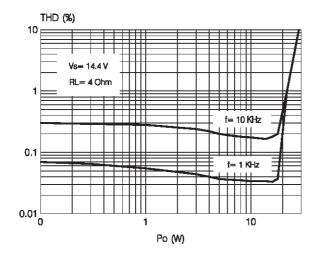


Figure 3: Quiescent Current vs. Supply Voltage

Figure 5: Output Power vs. Supply Voltage







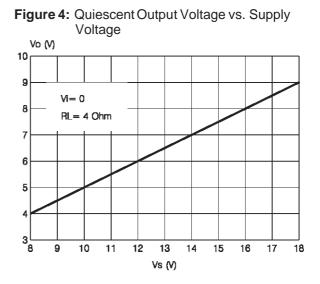
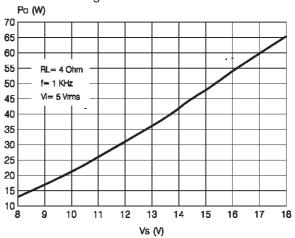
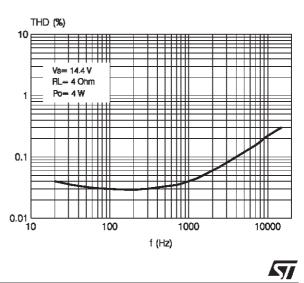


Figure 6: Maximum Output Power vs. Supply Voltage







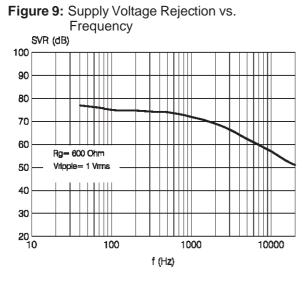
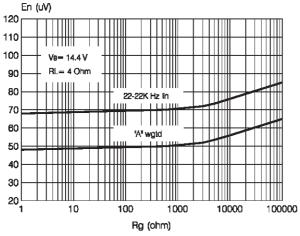


Figure 11: Output Noise vs. Source Resistance



APPLICATION HINTS (ref. to the circuit of fig. 1)

## <u>SVR</u>

Besides its contribution to the ripple rejection, the SVR capacitor governs the turn ON/OFF time sequence and, consequently, plays an essential role in the pop optimization during ON/OFF transients. To conveniently serve both needs, **ITS MINIMUM RECOMMENDED VALUE IS 10** $\mu$ F.

#### **INPUT STAGE**

The TDA7386's inputs are ground-compatible and can stand very high input signals ( $\pm$  8Vpk) without any performances degradation.

If the standard value for the input capacitors (0.1  $\mu\text{F})$  is adopted, the low frequency cut-off will amount to 16 Hz.

#### STAND-BY AND MUTING

STAND-BY and MUTING facilities are both

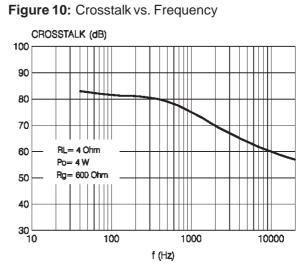
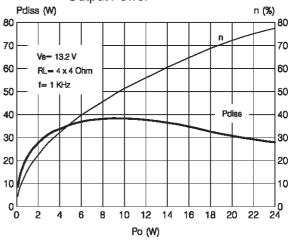


Figure 12: Power Dissipation & Efficiency vs. Output Power



CMOS-COMPATIBLE. If unused, a straight connection to Vs of their respective pins would be admissible. Conventional/low-power transistors can be employed to drive muting and stand-by pins in absence of true CMOS ports or microprocessors.

R-C cells have always to be used in order to smooth down the transitions for preventing any audible transient noises.

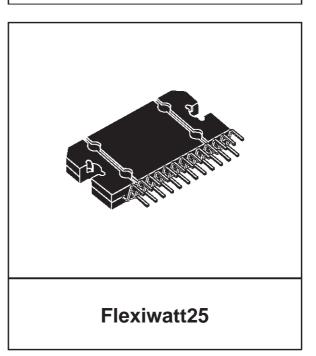
Since a DC current of about 10 uA normally flows out of pin 22, the maximum allowable muting-series resistance ( $R_2$ ) is 70K $\Omega$ , which is sufficiently high to permit a muting capacitor reasonably small (about 1 $\mu$ F).

If  $R_2$  is higher than recommended, the involved risk will be that the voltage at pin 22 may rise to above the 1.5 V threshold voltage and the device will consequently fail to turn OFF when the mute line is brought down.

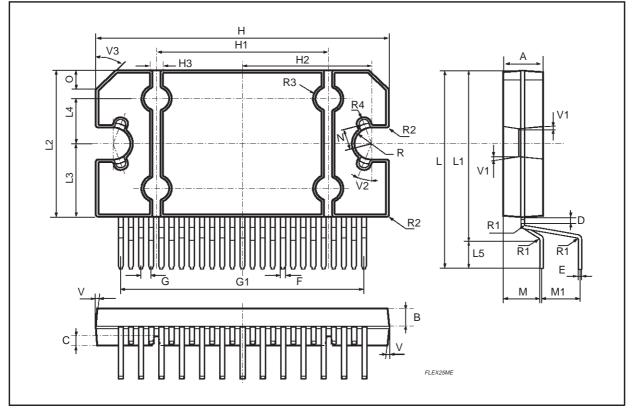
About the stand-by, the time constant to be assigned in order to obtain a virtually pop-free transition has to be slower than 2.5V/ms.

DIM.	mm			inch			
DIN.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
A	4.45	4.50	4.65	0.175	0.177	0.183	
В	1.80	1.90	2.00	0.070	0.074	0.079	
С		1.40			0.055		
D	0.75	0.90	1.05	0.029	0.035	0.041	
E	0.37	0.39	0.42	0.014	0.015	0.016	
F (1)			0.57			0.022	
G	0.80	1.00	1.20	0.031	0.040	0.047	
G1	23.75	24.00	24.25	0.935	0.945	0.955	
H (2)	28.90	29.23	29.30	1.138	1.150	1.153	
H1		17.00			0.669		
H2		12.80			0.503		
H3		0.80			0.031		
L (2)	22.07	22.47	22.87	0.869	0.884	0.904	
L1	18.57	18.97	19.37	0.731	0.747	0.762	
L2 (2)	15.50	15.70	15.90	0.610	0.618	0.626	
L3	7.70	7.85	7.95	0.303	0.309	0.313	
L4		5			0.197		
L5		3.5			0.138		
M	3.70	4.00	4.30	0.145	0.157	0.169	
M1	3.60	4.00	4.40	0.142	0.157	0.173	
N		2.20			0.086		
0		2			0.079		
R		1.70			0.067		
R1		0.5			0.02		
R2		0.3			0.12		
R3		1.25			0.049		
R4	0.50 0.019						
V	5° (Typ.)						
V1	3° (Typ.)						
V2	20° (Typ.)						
V3	45° (Typ.)						

# OUTLINE AND MECHANICAL DATA



(1): dam-bar protusion not included (2): molding protusion included



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